

PATENT
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants	Lynn David Bollinger, <i>et al.</i>
Serial No. - Pending	Filing Date: October 20, 2000
Title of Application:	Method for Rapid Thermal Processing of Substrates

Assistant Commissioner for Patents
Washington, DC 20231

Information Disclosure Statement by Applicants

Dear Sir:

As a means of complying with duty of disclosure set forth in 37 CFR §1.56, Applicants list the following references (copies of the listed patents and papers enclosed):

U.S. Patent Documents				
Exam. Initials	Class/ Subclass.	Document No.	Date	Name
MW	—	5,474,642	12/12/95	Vecleslav, <i>et al.</i>
MW	—	5,489,820	02/06/96	Vladimir, <i>et al.</i>
MW	—	5,562,841	10/08/96	Pavel, <i>et al.</i>

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October 20, 2000


Caroline Gahagan

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Foreign Patent Documents			
Exam. Initials	Document No.	Date	Country
<i>MW</i>	PCT/US97/08626	05/21/97	PCT
<i>MW</i>	PCT/US97/09069	05/28/97	PCT
<i>MW</i>	PCT/US97/09234	05/30/97	PCT
<i>MW</i>	PCT/US97/09252	05/30/97	PCT
<i>MW</i>	WO9745856	12/04/97	World
<i>MW</i>	WO9745857	12/04/97	World
<i>MW</i>	WO9746056	03/21/00	World
<i>MW</i>	WO9946805	09/16/99	World